L Number	Hits	Search Text	DB	Time stamp
1	14	(barrier\$2) near7(wet adj2 etch\$4) and ((contact\$2 adj hole\$2 via adj	USPAT;	2004/08/06 18:21
		hole\$2 through adj hole\$2) same((barrier\$2 liner\$2)with (titanium	US-PGPUB	
		aluminum "tio.sub.2" "al.sub.2o.sub.3")))		
2	1878	((contact\$2 adj hole\$2 via adj hole\$2 through adj hole\$2)	USPAT;	2004/08/06 18:07
		same((barrier\$2 liner\$2)with (titanium aluminum "tio.sub.2"	US-PGPUB	
		"al.sub.2o.sub.3")))		
3	14	(barrier\$2) near7(wet adj2 etch\$4) and ( ((contact\$2 adj hole\$2 via adj	USPAT;	2004/08/06 18:22
		hole\$2 through adj hole\$2) same((barrier\$2 liner\$2)with (titanium	US-PGPUB	
		aluminum "tio.sub.2" "al.sub.2o.sub.3"))))		
4	46	((contact\$2 adj hole\$2 via adj hole\$2 through adj hole\$2)	USPAT;	2004/08/06 18:22
		same((barrier\$2 liner\$2)with (titanium aluminum "tio.sub.2"	US-PGPUB	
		"al.sub.2o.sub.3")))and (atomic adj layer adj depost\$4 ald)		
5	68	((barrier\$2) near4 (bottom lower)) near7( etch\$4) and ((contact\$2 adj	USPAT;	2004/08/06 18:28
		hole\$2 via adj hole\$2 through adj hole\$2) same((barrier\$2 liner\$2)with	US-PGPUB	
		(titanium aluminum "tio.sub.2" "al.sub.2o.sub.3")))		
6	61	(plug\$2 fill\$4)and (((barrier\$2) near4 (bottom lower)) near7( etch\$4)	USPAT;	2004/08/06 18:18
		and ((contact\$2 adj hole\$2 via adj hole\$2 through adj hole\$2)	US-PGPUB	
		same((barrier\$2 liner\$2)with (titanium aluminum "tio.sub.2"		
		"al.sub.2o.sub.3"))))		
7	5	((plug\$2 fill\$4)and (((barrier\$2) near4 (bottom lower)) near7( etch\$4)	USPAT;	2004/08/06 18:21
		and ((contact\$2 adj hole\$2 via adj hole\$2 through adj hole\$2)	US-PGPUB	
		same((barrier\$2 liner\$2)with (titanium aluminum "tio.sub.2"		
		"al.sub.2o.sub.3"))))) and (atomic adj layer adj depost\$4 ald)		
8	91010	((manufactur\$4 fabricat\$4 method)near15(contact\$2))	EPO; JPO;	2004/08/06 18:21
	<b>=.</b> 0		DERWENT	***********
9	718	(atomic adj layer adj depost\$4 ald)	EPO; JPO;	2004/08/06 18:23
		//	DERWENT	2004/00/06 10 22
10	55	((contact\$2 adj hole\$2 via adj hole\$2 through adj hole\$2)	USPAT;	2004/08/06 18:22
		same((barrier\$2 liner\$2)with (titanium aluminum "tio.sub.2"	US-PGPUB	
11	9	"al.sub.2o.sub.3")))and (atomic adj layer adj deposit\$4 ald)	LICD ATC	2004/00/06 10 22
11	9	( ((contact\$2 adj hole\$2 via adj hole\$2 through adj hole\$2)	USPAT;	2004/08/06 18:22
		same((barrier\$2 liner\$2)with (titanium aluminum "tio.sub.2"  "al.sub.2o.sub.3")))and (atomic adj layer adj deposit\$4 ald)) not (	US-PGPUB	
		((contact\$2 adj hole\$2 via adj hole\$2 through adj hole\$2)		
		same((barrier\$2 liner\$2)with (titanium aluminum "tio.sub.2"		
		"al.sub.2o.sub.3")))and (atomic adj layer adj depost\$4 ald))		
12	993	(atomic adj layer adj deposit\$4 ald)	EPO; JPO;	2004/08/06 18:24
	,,,,	(atomic adjudyci adjudyci)	DERWENT	2004/00/00 10.24
13	29	(((manufactur\$4 fabricat\$4 method)near15(contact\$2))) and ( (atomic	EPO; JPO;	2004/08/06 18:25
	_,	adj layer adj deposit\$4 ald))	DERWENT	200 1/ 00/ 00 10:25
14	0	(wet near3 etch\$4)and (( ((manufactur\$4 fabricat\$4	EPO; JPO;	2004/08/06 18:25
		method)near15(contact\$2)) ) and ( (atomic adj layer adj deposit\$4 ald)))	DERWENT	2001/00/00 10:25
15	10	(etch\$4)and (( ((manufactur\$4 fabricat\$4 method)near15(contact\$2)) )	EPO; JPO;	2004/08/06 18:25
		and ( (atomic adj layer adj deposit\$4 ald)))	DERWENT	
16	0	((barrier\$2) near4 (bottom lower)) near7( etch\$4) and ((contact\$2 adj	EPO; JPO;	2004/08/06 18:28
· · · · · · · · · · · · · · · · ·		hole\$2 via adj-hole\$2 through adj hole\$2) same((barrier\$2 liner\$2)with	DERWENT	
		(titanium aluminum "tio.sub.2" "al.sub.2o.sub.3")))and ( ((manufactur\$4		
		fabricat\$4 method)near15(contact\$2)))		
17	3	((barrier\$2) near4 (bottom lower)) and (etch\$4) and ((contact\$2 adj	EPO; JPO;	2004/08/06 18:29
		hole\$2 via adj hole\$2 through adj hole\$2) and((barrier\$2 liner\$2)with	DERWENT	
		(titanium aluminum "tio.sub.2" "al.sub.2o.sub.3")))and ( ((manufactur\$4		
		fabricat\$4 method)near15(contact\$2)))		